- Dual Programmable LPC-12 Speech Synthesizers
- Simultaneous LPC and PCM Waveforms
- 8-Bit Microprocessor with 61 instructions
- 32 Twelve-Bit Words and 224 Bytes of RAM
- 3.3V to 6.5V CMOS Technology for Low Power Dissipation
- Direct Speaker Drive Capability
- Mask Selectable Internal or External Clock
- Internal Clock Generator that Requires No External Components
- Two Software-Selectable Clock Speeds
- 10-kHz or 8-kHz Speech Sample Rate

N PACKAGE (TOP VIEW) PA6 16 PA7 PA5 **1** 2 15 **∏** PB0 PA4 ∏ 3 14**∏** PA0 PA3 [] 13 DAC+ PA2 **1** 5 12 DAC-PA1 Π 11 V_{DD} 10 🛮 <u>Vss</u> PB1/OSC OUT [] 7 OSC IN 8 9 N INIT

description

The MSP50x3x family uses a revolutionary architecture to combine an 8-bit microprocessor, two speech synthesizers, ROM, RAM, and I/O in a low-cost single-chip system. The architecture uses the same arithmetic logic unit (ALU) for the two synthesizers and the microprocessor, thus reducing chip area and cost and enabling the microprocessor to do a multiply operation in 0.8 μs. The MSP50x3x family features two independent channels of linear predictive coding (LPC), which synthesize high-quality speech at a low data rate. Pulse-code modulation (PCM) can produce music or sound effects. LPC and PCM can be added together to produce a composite result. For more information, see the MSP50x3x User's Guide (literature number SPSU006).

Table 1. MSP50x3x Family

| DEVICE | AMOUNT OF ROM/PROM | FEATURES |
|----------|--------------------|--|
| MSP50C32 | 16K bytes mask ROM | 9/10 I/O lines |
| MSP50C33 | 32K bytes mask ROM | 9/10 I/O lines |
| MSP50C34 | 64K bytes mask ROM | 9/10 I/O lines, 24 I/O lines in die form |
| MSP50P34 | 64K bytes PROM | 9/10 I/O lines |
| MSP50C37 | 16K bytes mask ROM | 18 I/O lines, A/D converter/analog amplifier |
| MSP50P37 | 16K bytes PROM | 18 I/O lines, A/D converter/analog amplifier |



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



absolute maximum ratings over operating free-air temperature range†

| Supply voltage range, V _{DD} (see Note 1) | 0.3 V to 8 V |
|--|----------------------------------|
| Supply current, IDD or ISS (see Note 2) | 100 mA |
| Input voltage range, V _I (see Note 1) | 0.3 V to V _{DD} + 0.3 V |
| Output voltage range, VO (see Note 1) | 0.3 V to V _{DD} + 0.3 V |
| Storage temperature range | |

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (MSP50C32, MSP50C33, MSP50x34)

| | | | MAX | MAX | UNIT |
|-----------------|--------------------------------|---|-----|------|------|
| V_{DD} | Supply voltage [†] | | 3.3 | 6.5 | V |
| | | V _{DD} = 3.3 V | 2.5 | 3.3 | |
| VIH | High-level input voltage | V _{DD} = 5 V | 3.8 | 5 | V |
| | | V _{DD} = 6 V | 4.5 | 6 | |
| | | V _{DD} = 3.3 V | 0 | 0.65 | |
| V _{IL} | Low-level input voltage | V _{DD} = 5 V | 0 | 1 | V |
| | | V _{DD} = 6 V | 0 | 1.3 | |
| TA | Operating free-air temperature | Device functionality | 0 | 70 | °C |
| Rspeaker | Minimum speaker impedance | Direct speaker drive using 2 pin push-pull DAC option | 32 | | Ω |

[†] Unless otherwise noted, all voltages are with respect to VSS.

recommended operating conditions (MSP50x37)

| | | | MIN | MAX | UNIT |
|-----------------|--------------------------------|--------------------------------------|-----|-----|------|
| V_{DD} | Supply voltage [†] | | 4 | 6.5 | V |
| | | V _{DD} = 4 V | 3 | 4 | |
| VIH | High-level input voltage | V _{DD} = 5 V | 3.8 | 5 | V |
| | | V _{DD} = 6 V | 4.5 | 6 | |
| | | V _{DD} = 4 V | 0 | 1 | |
| V _{IL} | Low-level input voltage | V _{DD} = 5 V | 0 | 1.2 | V |
| | | V _{DD} = 6 V | 0 | 1.5 | |
| | MUX input voltage | Reference voltage = 6.5 V | 0 | 6.5 | V |
| TA | Operating free-air temperature | Device functionality | -10 | 70 | °C |
| Rspeaker | Minimum speaker impedance | Direct speaker drive using power amp | 8 | | Ω |



NOTES: 1. All voltages are with respect to ground.

^{2.} The total supply current includes the current out of all the I/O terminals and DAC terminals as well as the operating current of the device.

MSP50C32, MSP50C33, MSP50x34 electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-------------------|---|---|-------|-------|-------|------|
| \/- | Positive going threshold voltage (INIT) | V _{DD} = 3.5 V | | 2 | | V |
| V _{T+} | Positive-going threshold voltage (INIT) | V _{DD} = 6 V | | 3.4 | | V |
| \/_ | Negative going throughold voltage (INIT) | V _{DD} = 3.5 V | | 1.6 | | V |
| V _T _ | Negative-going threshold voltage (INIT) | V _{DD} = 6 V | | 2.3 | | V |
| \/. | Hyptoropia ()/- | V _{DD} = 3.5 V | | 0.4 | | V |
| V _{hys} | Hysteresis ($V_{T+} - V_{T-}$) (INIT) | V _{DD} = 6 V | | 1.1 | | V |
| l _{lkg} | Input leakage current (except for OSC IN) | | | | 2 | μΑ |
| Istandby | Standby current (INIT low, SETOFF) | | | | 10 | μΑ |
| | | V _{DD} = 3.3 V, V _{OH} = 2.75 V | | 2.1 | | |
| I _{DD} † | Supply current | V _{DD} = 5 V, V _{OH} = 4.5 V | | 3.1 | | mA |
| | | $V_{DD} = 6 \text{ V}, \qquad V_{OH} = 5.5 \text{ V}$ | | 4.5 | | |
| | | V _{DD} = 3.3 V, V _{OH} = 2.75 V | -4 | -12 | | |
| | | $V_{DD} = 5 \text{ V}, \qquad V_{OH} = 4.5 \text{ V}$ | -5 | -14 | | mA |
| | High level cotton to compact (DA DD) | V _{DD} = 6 V, V _{OH} = 5.5 V | -6 | -15 | | |
| ЮН | High-level output current (PA, PB) | $V_{DD} = 3.3 \text{ V}, \qquad V_{OH} = 2.2 \text{ V}$ | -8 | -20 | | |
| | | V _{DD} = 5 V, V _{OH} = 3.33 V | -14 | -40 | | mA |
| | | V _{DD} = 6 V, V _{OH} = 4 V | -20 | -51 | | |
| | | $V_{DD} = 3.3 \text{ V}, \qquad V_{OL} = 0.5 \text{ V}$ | 5 | 9 | | |
| | Low-level output current (PA, PB) | $V_{DD} = 5 \text{ V}, \qquad V_{OL} = 0.5 \text{ V}$ | 5 | 9 | | mA |
| | | $V_{DD} = 6 \text{ V}, \qquad V_{OL} = 0.5 \text{ V}$ | 5 | 9 | | |
| IOL | | V _{DD} = 3.3 V, V _{OL} = 1.1 V | 10 | 19 | | |
| | | $V_{DD} = 5 \text{ V}, \qquad V_{OL} = 1.67 \text{ V}$ | 20 | 29 | | mA |
| | | $V_{DD} = 6 \text{ V}, \qquad V_{OL} = 2 \text{ V}$ | 25 | 35 | | |
| | | V _{DD} = 3.3 V, V _{OH} = 2.75 V | -30 | -50 | | |
| | | $V_{DD} = 5 \text{ V}, \qquad V_{OH} = 4.5 \text{ V}$ | -35 | -60 | | mA |
| Lave | High level cutout current (D/A) | $V_{DD} = 6 \text{ V}, \qquad V_{OH} = 5.5 \text{ V}$ | -40 | -65 | | |
| ЮН | High-level output current (D/A) | $V_{DD} = 3.3 \text{ V}, \qquad V_{OH} = 2.3 \text{ V}$ | -50 | -90 | | |
| | | $V_{DD} = 5 \text{ V}, \qquad V_{OH} = 4 \text{ V}$ | -90 | -140 | | mA |
| | | $V_{DD} = 6 V$, $V_{OH} = 5 V$ | -100 | -150 | | |
| | | $V_{DD} = 3.3 \text{ V}, \qquad V_{OL} = 0.5 \text{ V}$ | 50 | 80 | | |
| | | $V_{DD} = 5 \text{ V}, \qquad V_{OL} = 0.5 \text{ V}$ | 70 | 90 | | mA |
| I.e. | Low lovel output output (D/A) | $V_{DD} = 6 \text{ V}, \qquad V_{OL} = 0.5 \text{ V}$ | 80 | 110 | | |
| IOL | Low-level output current (D/A) | $V_{DD} = 3.3 \text{ V}, \qquad V_{OL} = 1 \text{ V}$ | 100 | 140 | | |
| | | $V_{DD} = 5 \text{ V}, \qquad V_{OL} = 1 \text{ V}$ | 140 | | | mA |
| | | $V_{DD} = 6 V$, $V_{OL} = 1 V$ | 150 | | | |
| | Pullup resistance | Resistors selected by software ar connected between terminal and V _D | | 20 | 50 | kΩ |
| fosc(low) | Oscillator frequency [‡] | $V_{DD} = 5 \text{ V}, \qquad T_A = 25^{\circ}\text{C},$ | 14.89 | 15.36 | 15.86 | MHz |
| fosc(high) | Oscillator frequency‡ | Target frequency = 15.36 MHz $V_{DD} = 5 \text{ V}, \qquad T_{A} = 25^{\circ}\text{C},$ Target frequency = 19.2 MHz | 18.62 | 19.2 | 19.7 | MHz |

[†] Operating current assumes all inputs are tied to either V_{SS} or V_{DD} with no input currents due to programmed pullup resistors. The DAC output and other outputs are open circuited.

[‡] The frequency of the internal clock has a temperature coefficient of approximately -0.2 %/°C and a V_{DD} coefficient of approximately ±1%/V.



MSP50x37 electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| | PARAMETER | TEST C | CONDITIONS | MIN | TYP | MAX | UNIT |
|-------------------|--|--|--|------------|-------|-------|------|
| \/- | Desitive going threshold voltage (INIT) | V _{DD} = 4.5 V | | | 2.7 | | V |
| V _{T+} | Positive-going threshold voltage (INIT) | V _{DD} = 6 V | | | 3.65 | | v |
| V _T _ | Negative-going threshold voltage (INIT) | V _{DD} = 4.5 V | V _{DD} = 4.5 V | | 2.3 | | V |
| V I – | Negative-going threshold voltage (INTT) | V _{DD} = 6 V | | | 3.15 | | V |
| ٧, | Hysteresis (V _{T+} – V _{T-}) (INIT) | V _{DD} = 4.5 V | | | 0.4 | | V |
| V _{hys} | 11ysteresis (v + - v _) (IIVI1) | V _{DD} = 6 V | | | 0.5 | | V |
| l _{lkg} | Input leakage current (except for OSC IN) | | | | | 1 | μΑ |
| Istandby | Standby current (INIT low, SETOFF) | | | | 10 | | μΑ |
| | Cumply oursent | Power amplifier | is on | | 25 | | A |
| I _{DD} † | Supply current | Power amplifier | is off | | 10 | | mA |
| | | $V_{DD} = 4 V$, | V _{OH} = 3.5 V | -4 | -6 | | |
| | | $V_{DD} = 5 V$, | V _{OH} = 4.5 V | – 5 | -7.5 | | mA |
| lou | High-level output current (PA, PB, PD) | $V_{DD} = 6 V$, | V _{OH} = 5.5 V | -6 | -9.2 | | |
| ЮН | | $V_{DD} = 4 V$, | V _{OH} = 2.65 V | -8 | -13 | | mA |
| | | $V_{DD} = 5 V$, | V _{OH} = 3.33 V | -14 | -20 | | |
| | | $V_{DD} = 6 V$, | V _{OH} = 4 V | -20 | -29 | | |
| | | $V_{DD} = 4 V$, | $V_{OL} = 0.5 V$ | 20 | 28 | | |
| | | $V_{DD} = 5 V$, | $V_{OL} = 0.5 \text{ V}$ | 26 | 34 | | mA |
| lOL | Low-level output current (PA4 – PA7) | $V_{DD} = 6 V$ | $V_{OL} = 0.5 V$ | 30 | 39 | | |
| I OL | Low level output current (1744 1747) | $V_{DD} = 4 V$, | V _{OL} = 1.33 V | 40 | 54 | | |
| | | $V_{DD} = 5 V$, | V _{OL} = 1.67 V | 60 | 74 | | mA |
| | | $V_{DD} = 6 V$, | V _{OL} = 2 V | 82 | 103 | | |
| | | $V_{DD} = 4 V$, | V _{OL} = 0.5 V | 10 | 17 | | |
| | | $V_{DD} = 5 V$, | V _{OL} = 0.5 V | 13 | 20 | | mA |
| lOL | Low-level output current (PA0 – PA3, PB, PD)) | $V_{DD} = 6 V$, | $V_{OL} = 0.5 \text{ V}$ | 15 | 25 | | |
| I OL | Low level output outlieft (1716-1716, 12, 12)) | $V_{DD} = 4 V$, | V _{OL} = 1.33 V | 20 | 32 | | |
| | | $V_{DD} = 5 V$ | V _{OL} = 1.67 V | 30 | 52 | | mA |
| | | $V_{DD} = 6 V$, | V _{OL} = 2 V | 41 | 71 | | |
| | Pullup resistance | Resistors selected between | ted by software and een terminal and VDD | 15 | 30 | 60 | kΩ |
| fosc(low) | Oscillator frequency [‡] | V _{DD} = 5 V, Target frequence | $T_A = 25^{\circ}C$, y = 15.36 MHz | 14.89 | 15.36 | 15.82 | MHz |
| fosc(high) | Oscillator frequency [‡] | V _{DD} = 5 V, Target frequence | T _A = 25°C, | 18.62 | 19.2 | 19.77 | MHz |

[†] Operating current assumes all inputs are tied to either V_{SS} or V_{DD} with no input currents due to programmed pullup resistors. The DAC output and other outputs are open circuited.



[‡] The frequency of the internal clock has a temperature coefficient of approximately -0.2 %/°C and a VDD coefficient of approximately ±1.4%/V.

MSP50x37 Power Amplifier Electrical Characteristics Over Recommended Operating Free-Air Temperature Range

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---------------------------|---|-----|-----|-----|------|
| Differential output power | $V_{DD} = 5 \text{ V}, f = 1 \text{ kHz}, R_L = 8 \Omega$ | | 500 | | mW |
| Bandwidth | | | | 3.5 | kHz |

MSP50x37 ADC Electrical Characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

| PARAMETER | MIN | TYP | MAX | UNIT |
|------------------|-----|------|-----|--------------|
| Linearity | | ±0.5 | | LSB |
| Offset | | ±1.5 | | LSB |
| Full scale error | | ±1.5 | | LSB |
| Conversion time | | 40 | | Instructions |

switching characteristics (MSP50C32, MSP50C33, MSP50x34)

| | PARAMETER TEST CONDITIONS | | | | MIN | NOM | MAX | UNIT |
|----------------|---------------------------|---------------------------|-------------------------|------------|-----|-----|-----|------|
| t _r | Rise time, PA, PB, D/A | $V_{DD} = 3.3 V,$ | $C_L = 100 pF$, | 10% to 90% | | 50 | | ns |
| t _f | Fall time, PA, PB, D/A | $V_{DD} = 3.3 \text{ V},$ | $C_L = 100 \text{ pF},$ | 10% to 90% | | 50 | | ns |

switching characteristics (MSP50x37)

| | PARAMETER | R TEST CONDITIONS | | | MIN | NOM | MAX | UNIT |
|----------------|-----------------------|-------------------|------------------|------------|-----|-----|-----|------|
| t _r | Rise time, PA, PB, PD | $V_{DD} = 4 V$, | $C_L = 100 pF$, | 10% to 90% | | 22 | | ns |
| t _f | Fall time, PA, PB, PD | $V_{DD} = 4 V$ | $C_L = 100 pF$, | 10% to 90% | | 10 | | ns |

timing requirements

| | | | MIN | MAX | UNIT |
|----------------------------|--|--------------------------------|-----|-----|------|
| Initialization | | | | | |
| ^t INIT | INIT pulsed low while the MSP50x3x has power applied (see Figure 1) | | 1 | | μs |
| Wakeup | | | | | |
| tsu(wakeup) | Setup time prior to wakeup terminal negative transition (see Figure 2) | | 1 | | μs |
| External Inter | rupt | | | | |
| | Octor the minute PA terminal exacting two effects are 20 | f _{clock} = 15.36 MHz | 1 | | |
| ^t su(interrupt) | (interrupt) Setup time prior to B1 terminal negative transition (see Figure 3) | | 1.5 | | μs |
| Writing (Slav | e Mode) | | | | |
| tsu1(B1) | Setup time, B1 low before B0 goes low (see Figure 4) | | 20 | | ns |
| t _{su(d)} | Setup time, data valid before B0 goes high (see Figure 4) | | 100 | | ns |
| ^t h1(B1) | Hold time, B1 low after B0 goes high (see Figure 4) | | 20 | | ns |
| ^t h(d) | Hold time, data valid after B0 goes high (see Figure 4) | | 30 | | ns |
| t _W | Pulse duration, B0 low (see Figure 4) | | 100 | | ns |
| t _r | Rise time, B0 (see Figure 4) | | | 50 | ns |
| t _f | Fall time, B0 (see Figure 4) | | | 50 | ns |
| Reading (Sla | ve Mode) | | | | |
| tsu2(B1) | Setup time, B1 before B0 goes low (see Figure 5) | | 20 | | ns |
| ^t h2(B1) | Hold time, B1 after B0 goes high (see Figure 5) | | 20 | | ns |
| t _{dis} | Output disable time, data valid after B0 goes high (see Figure 5) | | 0 | 30 | ns |
| t _W | Pulse duration, B0 low (see Figure 5) | | 100 | | ns |
| t _r | Rise time, B0 (see Figure 5) | | | 50 | ns |
| t _f | Fall time, B0 (see Figure 5) | | | 50 | ns |
| t _d | Delay time for B0 low to data valid (see Figure 5) | | | 50 | ns |

PARAMETER MEASUREMENT INFORMATION

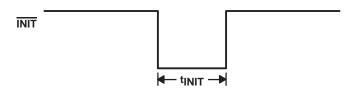


Figure 1. Initialization Timing Diagram

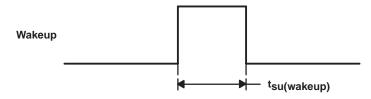


Figure 2. Wakeup Terminal Setup Timing Diagram



PARAMETER MEASUREMENT INFORMATION

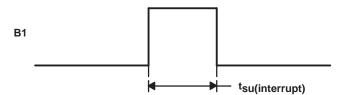


Figure 3. External Interrupt Terminal Setup Timing Diagram

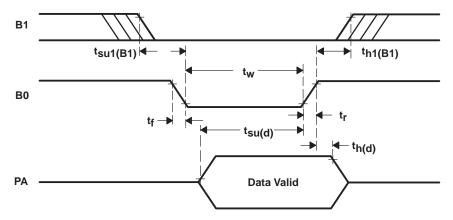


Figure 4. Write Timing Diagram (Slave Mode)

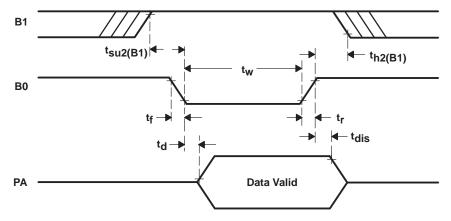


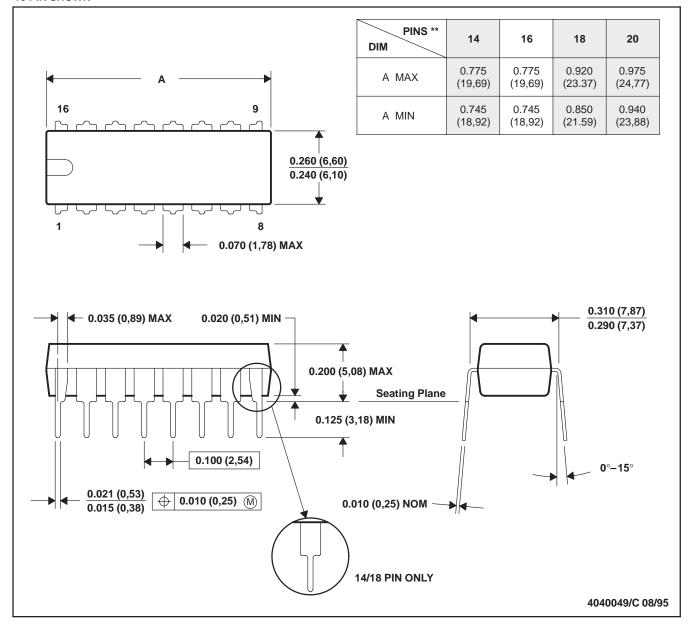
Figure 5. Read Timing Diagram (Slave Mode)

MECHANICAL DATA

N (R-PDIP-T**)

16 PIN SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001 (20 pin package is shorter then MS-001.)



IMPORTANT NOTICE

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

CERTAIN APPLICATIONS USING SEMICONDUCTOR PRODUCTS MAY INVOLVE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS. INCLUSION OF TI PRODUCTS IN SUCH APPLICATIONS IS UNDERSTOOD TO BE FULLY AT THE CUSTOMER'S RISK.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.

Copyright © 1998, Texas Instruments Incorporated